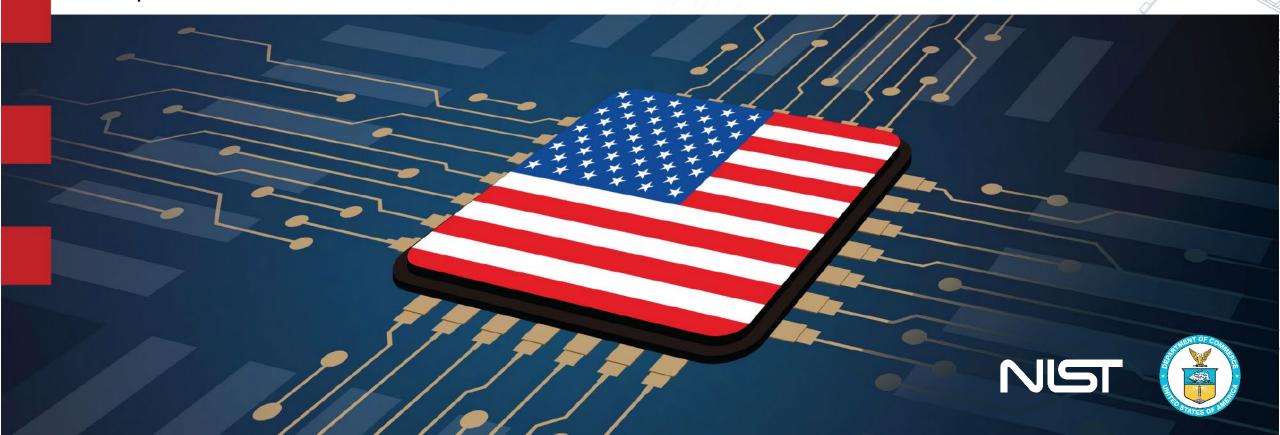




Presented by Donna Dubinsky, Sreenivas Ramaswamy and Jason Boehm September 2022







WELCOME

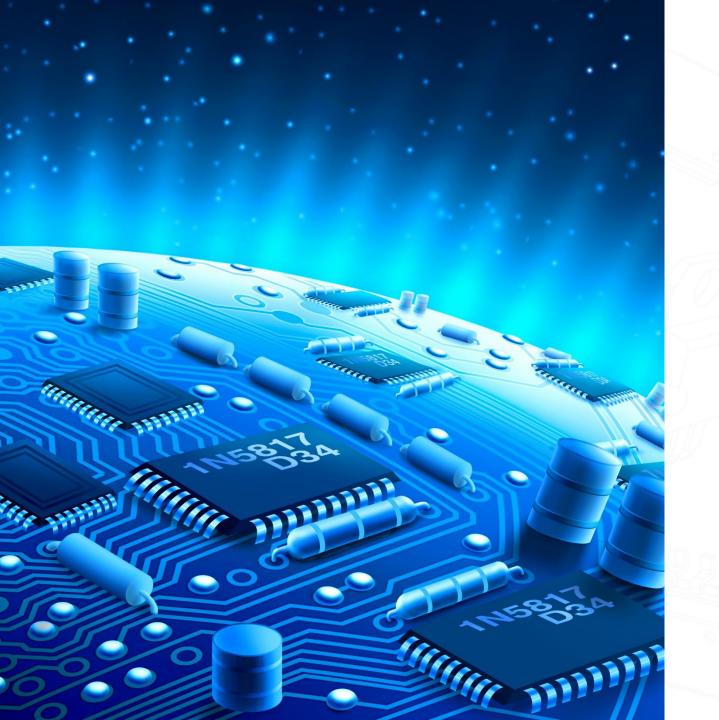
- We look forward to your questions. Click the Q&A button,
 type your question, and click "Post Question" to submit.
- We will answer as many questions as possible today.
- Visit CHIPS.gov
 - Get the strategy paper
 - Sign up for email updates





CHIPS for America Vision

Donna Dubinsky
Senior Counselor to the Secretary
for CHIPS Implementation





Chips are the foundation of the modern world

Chips were invented in America



But most chips are made outside of the U.S.

Logic chip production by country, 2021



Memory chip production by country, 2021



CHIPS for America Vision



Economic Security

This act enables us to build more resilient supply chains for important components.



National Security

This act enables us to bring the most sophisticated technologies back to the U.S.





Future Innovation

Chips are key to the technologies and industries of the future, so we need to be at the forefront. This act will ensure long-term U.S. leadership in the sector.

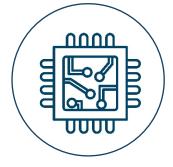


CHIPS for America Overview

Sreenivas Ramaswamy
Senior Advisor to the Secretary of Commerce

CHIPS for America will:





Return leadingedge chip manufacturing to U.S.



Expand capacity to make current/mature chips and critical supplies



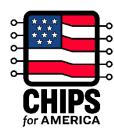
Reinforce U.S. strengths in chip design and equipment



Grow a U.S. workforce and strengthen communities

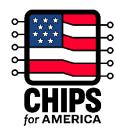
Create a domestic semiconductor ecosystem for national and economic security

Guiding Principles



- 1 Meet economic and national security needs
- 2 Ensure long-term leadership in the sector
- 3 Strengthen and expand regional clusters
- 4 Catalyze private sector investment
- Generate benefits for a range of stakeholders and communities
- 6 Protect taxpayer dollars

CHIPS for America Incentives



\$39 billion for manufacturing

Two component programs:

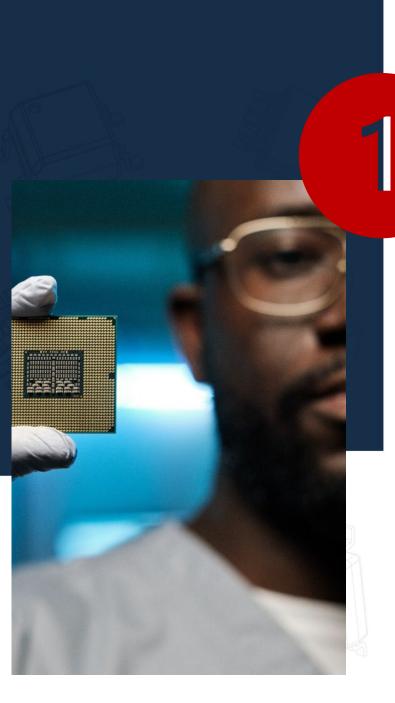
- 1. Attract largescale investments in advanced technologies such as leading-edge logic and memory
- 2. Incentivize expansion of manufacturing capacity for mature and other types of semiconductors

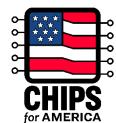
\$11 billion for R&D

- National Semiconductor Technology Center
- National Advanced Packaging Manufacturing Program
- Manufacturing USA institute(s)
- National Institute of Standards and Technology measurement science

Together with CHIPS initiatives from other agencies, including DOD, State, NSF, and Treasury

Workforce development





LARGE-SCALE INVESTMENTS IN LEADING-EDGE LOGIC AND MEMORY MANUFACTURING CLUSTERS

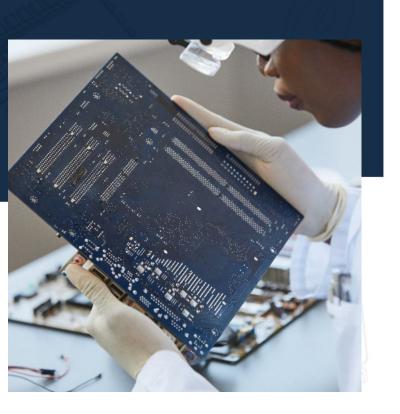
Projects could include:

- Construction or expansion of manufacturing facilities to fabricate, package, assemble and test leading edge logic and memory chips
- Multiple high-cost, production lines and associated supplier ecosystems



EXPANDING MANUFACTURING CAPACITY FOR MATURE AND CURRENT-GENERATION CHIPS, NEW AND SPECIALTY TECHNOLOGIES, AND FOR SUPPLIERS TO THE INDUSTRY





Projects could include:

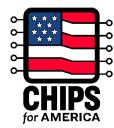
- Construction or expansion of facilities for the fabrication, packaging assembly and testing of mature and currentgeneration semiconductors
- Facilities to produce new or specialty technologies
- Facilities that manufacture equipment and materials
- Equipment upgrades



CHIPS for America Overview R&D

Jason Boehm
Chief of Staff
National Institute of Standards and Technology

Research & Development



- Strengthen and advance
 U.S. leadership in R&D
- An integrated ecosystem that drives innovation
- In partnership with industry, academia, government, and allies
- A strategic view of R&D infrastructure, participant value-proposition, and technology focus areas
- Informed by the Industrial Advisory Committee

National Semiconductor Technology Center

Metrology R&D (NIST)

National Advanced
Packaging
Manufacturing
Program

Manufacturing USA institutes (up to three)

Members announced today!



Sreenivas RamaswamySenior Advisor to the Secretary of Commerce

CHIPS Incentives Program Implementation:
How to Get Started

Timeline



Summer 2022

Fall 2022

Winter 2023

Spring 2023

Summer 2023

Fall 2023

Winter 2024

CHIPS & Science Act of 2022 passed into law and signed by President Biden

Funding application process released; Rolling applications begin

Review, Due Diligence & Funding

A Strategy for the CHIPS for America Fund released

CHIPS for America is launched with EO on the implementation of CHIPS and Science Act of 2022

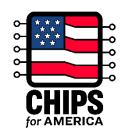
IAC members announced

CHIPS webinars and briefings

CHIPS Program Office (CPO) and CHIPS R&D Office are founded, senior leadership announced

We're just getting started...

Eligibility Criteria



For organizations that are	that can substantially	a U.S. facility for	of
private	finance	fabrication	semiconductors
non-profit	construct	assembly	materials
consortia	expand	testing	manufacturing equipment
	modernize	packaging	oquipmone
		production	
		R&D	

^{*}More details will be released in the funding application document

Guidance for Incentive Applicants

HOW DO YOU GET STARTED?



Increase scale and attract private capital

Leverage collaborations to build out ecosystems

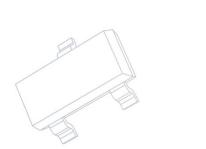
Secure additional incentives and support to build clusters

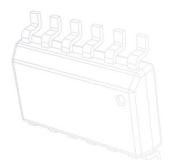
Establish a secure and resilient supply chain

Expand the workforce pipeline

Create inclusive opportunities for businesses and communities

- Consider if you can broaden the scale of previously contemplated projects
- Don't wait, find other investors now





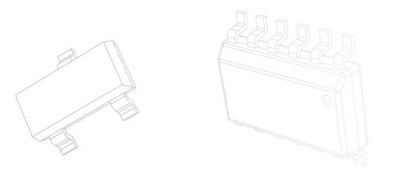




INCREASE SCALE AND ATTRACT CAPITAL

- Economies of scale matter; large fabs are more competitive, more attractive for suppliers to co-locate
- Minimum federal investment required to attract significant private capital
- CPO will use loans and loan guarantees to leverage the impact of government grants to leverage funding, and extend CHIPS benefits to a wider set of small manufacturers

- Go to suppliers now and build a consortium
- Go to customers now and build a consortium



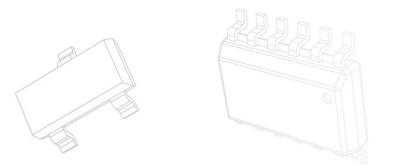




LEVERAGE COLLABORATIONS TO BUILD OUT ECOSYSTEMS

- Purchase commitments and other initiatives to improve demand transparency
- Collaboration between investors, customers, designers, and suppliers is encouraged and will ensure investments match up with future market demand
- Manufacturing incentives will principally support fabs, but fabless companies will benefit substantially and projects that enable fabless design tools and IP, are flexible, and have better portability are encouraged

- Talk to states and localities about their interest in supporting your project
- Seek out long-term state & local tax credits that can ensure continued investment in upgrading and expanding facilities



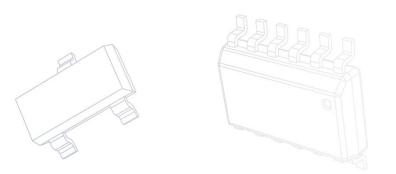




SECURE ADDITIONAL INCENTIVES AND SUPPORT TO BUILD CLUSTERS

- The 2021 NDAA requires that applicants demonstrate they have secured incentives from state or local government
- Encouraged projects:
 - include state and local incentive packages with the potential for large spill-over benefits,
 - · are based on performance
 - boost regional and local economies gains and semiconductor ecosystems rather than just a single company
- Encouraged proposals are ones that move quickly, reduce project risk, demonstrate ample local support/regional cooperation, and provide broad based benefits

- Plan for your project to have a robust information and data security posture
- Begin upgrading your systems



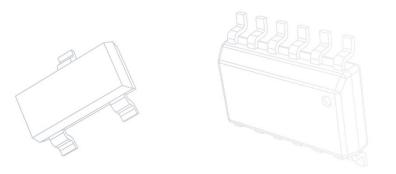




ESTABLISH A SECURE AND RESILIENT SEMICONDUCTOR SUPPLY CHAIN

- We expect to prioritize projects that adhere to standards and guidelines on information security, data tracking and verification, and that collaborate on further development and adoption of such standards
- We expect to prioritize investments that address supply chain risks including,
 - poor demand visibility
 - single sourcing and geographic chokepoints
 - transport and logistical bottlenecks
 - weather-related disruptions
 - counterfeiting and tampering
 - IP theft
 - cybersecurity vulnerability

- Plan to develop or scale workforce programs now
- Find proven training partners like unions, community colleges, and more
- Begin to update or rethink your hiring practices



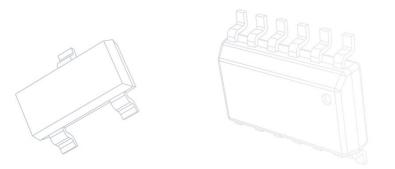




EXPAND THE WORKFORCE PIPELINE TO MATCH INCREASED DOMESTIC CAPACITY WORKFORCE NEEDS

- We expect to prioritize projects that include effective and creative workforce development solutions
- Programs should be inclusive of populations that have traditionally been underrepresented in the industry
- Encouraged programs:
 - paid training and experiential apprenticeship programs
 - industry to hire based on skills, not just degrees
 - wrap around services
 - connect trainees to jobs
 - exceeding the local prevailing wage including basic benefits and/or are unionized

- Don't wait for the application, begin outreach now
- Connect with organizations that can assist this effort, like the Minority Business Development Agency







CREATE INCLUSIVE AND BROADLY SHARED OPPORTUNITIES FOR BUSINESSES

- Investments should result in measurable benefits to small and underrepresented businesses, including;
 - Minority-owned
 - Veteran-owned
 - Women-owned
 - Rural
- We expect to prioritize projects that proactively work to ensure that such businesses are included



Accountability



Projects must be economically viable and compatible with strategy

Beneficiaries must meet performance, reporting, audit, and oversight requirements

Beneficiaries may not send funded technology abroad or engage with countries of concern

Workers on funded construction projects to earn prevailing wages

Priority to programs that engage a diversity of participants

Public funds cannot be used for stock buybacks or dividend payments

Funds to be returned if taxpayer funds are misused



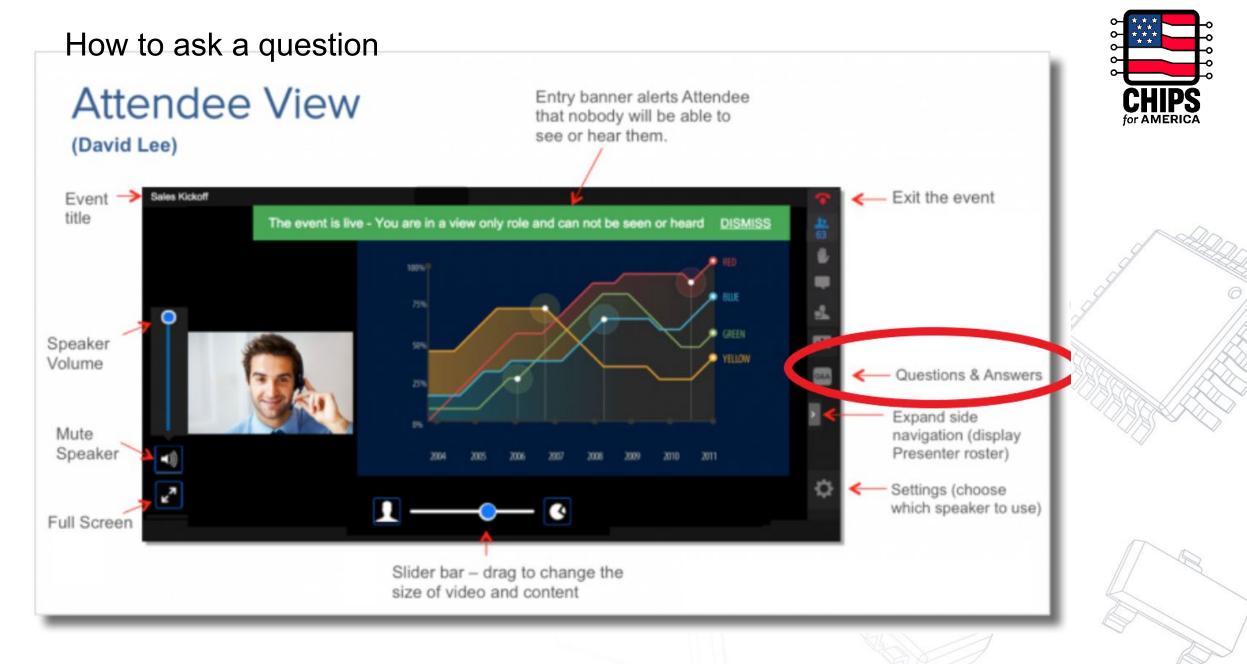




- Funding application process
 - Will be announced in February 2023 (6 months from enactment)
 - Proposals considered on a rolling basis
- Learn more
 - Visit CHIPS.gov
 - Read the Implementation Strategy
 - Join our mailing list



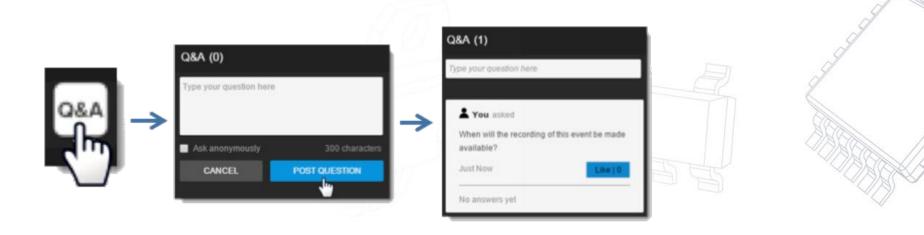
Question and Answers

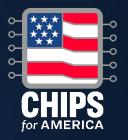


How to submit your question



Click the Q&A button, type out your question, and click "Post Question".





Thank you for attending